

General Description

The MAX4607/MAX4608/MAX4609 dual analog switches feature low on-resistance of 2.5Ω max. On-resistance is matched between switches to 0.5Ω max and is flat (0.5Ω max) over the specified signal range. Each switch can handle rail-to-rail analog signals. The off-leakage current is only 2.5nA max at +85°C. These analog switches are ideal in low-distortion applications and are the preferred solution over mechanical relays in automatic test equipment or applications where current switching is required. They have low power requirements, require less board space, and are more reliable than mechanical relays.

The MAX4607 has two normally closed (NC) switches, the MAX4608 has two normally open (NO) switches, and the MAX4609 has one NC and one NO switch.

These switches operate from a single supply of +4.5V to +36V or from dual supplies of $\pm 4.5V$ to $\pm 20V$. All digital inputs have +0.8V and +2.4V logic thresholds, ensuring TTL/CMOS-logic compatibility when using dual ±15V or a single +12V supply.

	<u> </u>
Reed Relay Replacement	PBX, PABX Systems
Test Equipment	Audio-Signal Routing
Communication Systems	Avionics

Low On-Resistance (2.5Ω max)

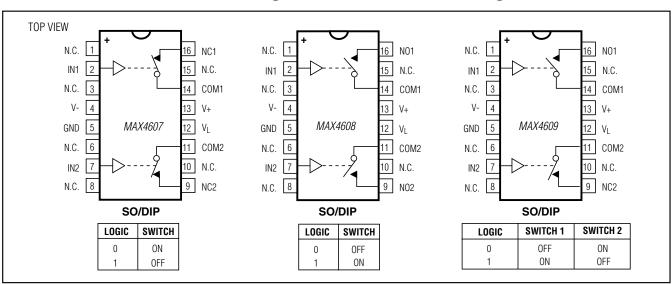
- Guaranteed RON Match Between Channels $(0.5\Omega max)$
- Guaranteed RON Flatness over Specified Signal Range (0.5Ω max)
- Rail-to-Rail Signal Handling
- Guaranteed ESD Protection > 2kV per Method 3015.7
- Single-Supply Operation: +4.5V to +36V Dual-Supply Operation: ±4.5V to ±20V
- TTL/CMOS-Compatible Control Inputs

Ordering Information

Features

PART	TEMP RANGE	PIN-PACKAGE					
MAX4607CSE	0°C to +70°C	16 Narrow SO					
MAX4607CPE	0°C to +70°C	16 Plastic DIP					
MAX4607ESE	-40°C to +85°C	16 Narrow SO					
MAX4607EPE -40°C to +85°C 16 Plastic DIP							
Ordering Information continued at end of data sheet.							

Devices are also available in a lead(Pb)-free/RoHS-compliant package. Specify lead-free by adding "+" to the part number when ordering.



Pin Configurations/Functional Diagrams/Truth Tables

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maximintegrated.com.

ABSOLUTE MAXIMUM RATINGS

V+ to GND0.3V to +44V
V- to GND+0.3V to -44V
V+ to V0.3V to +44V
V _L to GND(GND - 0.3V) to (V+ + 0.3V)
All Other Pins to GND (Note 1)(V 0.3V) to (V+ + 0.3V)
Continuous Current (COM_, NO_, NC_)±100mA
Peak Current (COM_, NO_, NC_)
(pulsed at 1ms, 10% duty cycle) ±300mA
Continuous Power Dissipation ($T_A = +70^{\circ}C$)
Narrow SO (derate 8.70mW/°C above +70°C)696mW
Plastic DIP (derate 10.53mW/°C above +70°C)842mW

Operating Temperature Ranges	
MAX460_C_E	0°C to +70°C
MAX460_E_E	40°C to +85 °C
Soldering Temperature (reflow)	
Lead(Pb)-Free Packages	+260°C
Packages Containing Lead(Pb)	+240°C
Storage Temperature Range	
Lead Temperature (soldering, 10s)	+300°C

Note 1: Signals on NC_, NO_, COM_, or IN_, exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—Dual Supplies

(V+ = +15V, V- = -15V, V_L = +5V, V_{IN_H} = +2.4V, V_{IN_L} = +0.8V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS			MIN	ТҮР	МАХ	UNITS
ANALOG SWITCH					•			
Input Voltage Range (Note 3)	V _{COM} _, V _{NO} _, V _{NC} _				V-		V+	V
COM_ to NO_, COM_ to NC_	R _{ON}	I _{COM} = 10mA, V _{NO}	$T_A = +25^{\circ}C$			1.6	2.5	Ω
On-Resistance	TION	or $V_{NC} = \pm 10V$	$T_A = T_{MIN} t$	o T _{MAX}			3	32
COM_ to NO_, COM_ to NC_			$T_A = +25^{\circ}C$			0.05	0.4	
On-Resistance Match Between Channels (Note 4)	ΔR_{ON}	or V_{NC} = -5V, 0, 5V	$\begin{array}{c} I_{COM} = 10 \text{mA}, V_{NO} \\ \text{or } V_{NC} = -5 \text{V}, 0, 5 \text{V} \end{array} T_{A} = T_{MIN} \text{ to } T_{MAX} \end{array}$				0.5	Ω
COM_ to NO_, COM_ to NC_		ICOM_ = 10mA, V _{NO_}	T _A = +25°C			0.1	0.4	0
On-Resistance Flatness (Note 5)	R _{FLAT} (ON))		o T _{MAX}			0.5	Ω
		$V_{COM_{-}} = \pm 10V, V_{NO_{-}}$ or $V_{NC_{-}} = \pm 10V$	$T_A = +25^{\circ}C$		-0.5	+0.01	+0.5	
Off-Leakage Current (NO_ or NC_) (Note 6)	I _{NO_} , I _{NC_}		T _A = T _{MIN}	C, E	-2.5		+2.5	nA
	or $v_{NC} = \pm 10v$		to T _{MAX}	М	-30		30	
			$T_{A} = +25^{\circ}C$		-0.5	+0.01	0.5	
COM_ Off-Leakage Current (Note 6)	ICOM_(OFF)	$V_{COM} = \pm 10V, V_{NO}$ or $V_{NC} = \pm 10V$	$T_A = T_{MIN}$	C, E	-2.5		+2.5	nA
		01 VNC 110V	to T _{MAX}	М	-30		30	
		$V_{COM} = \pm 10V, V_{NO}$	$T_A = +25^{\circ}C$;	1	0.02	1	
COM_ On-Leakage Current (Note 6)	ICOM_(ON)	or $V_{NC} = \pm 10V$ or	$T_A = T_{MIN}$	C, E	-10		10	nA
(Note 6)		unconnected	to T _{MAX}	М	-120		+120	
LOGIC INPUT								
Input Current with Input Voltage High	I _{IN_H}	V_{IN} = 2.4V, all others = 0.8V			-0.500	+0.001	+0.500	μA
Input Current with Input Voltage Low	l _{IN_L}	$V_{IN} = 0.8V$, all others = 2.4V			-0.500	+0.001	+0.500	μΑ

2.5 Ω , Dual, SPST, CMOS Analog Switches

ELECTRICAL CHARACTERISTICS—Dual Supplies (continued)

(V+ = +15V, V- = -15V, V_L = +5V, V_{IN_H} = +2.4V, V_{IN_L} = +0.8V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	C	ONDITIONS	MIN	ТҮР	MAX	UNITS	
Logic Input High Voltage	Vin_h				1.7		V	
Logic Input Low Voltage	V _{IN_L}				1.7	0.8	V	
POWER SUPPLY								
Power-Supply Range				±4.5		±20.0	V	
Positive Supply Current	l+		$T_A = +25^{\circ}C$	-0.5	+0.001	+0.5		
Positive Supply Current	1+	$V_{IN} = 0 \text{ or } 5V$	$T_A = T_{MIN}$ to T_{MAX}	-5		+5	μA	
Nagativa Supply Current	-	$V_{IN} = 0 \text{ or } 5V$	$T_A = +25^{\circ}C$	-0.5	+0.001	+0.5		
Negative Supply Current	1-	VIN = 0.012 V	$T_A = T_{MIN}$ to T_{MAX}	-5		+5	μA	
Logio Supply Current	С	V/w O or EV/	$T_A = +25^{\circ}C$	-0.5	+0.001	+0.5	5	
Logic Supply Current		$V_{IN} = 0 \text{ or } 5V$	$T_A = T_{MIN}$ to T_{MAX}	-5		+5	μA	
	1	$V_{IN} = 0 \text{ or } 5V$	$T_A = +25^{\circ}C$	-0.5	+0.001	+0.5	μA	
Ground Current	IGND		$T_A = T_{MIN}$ to T_{MAX}	-5		+5		
SWITCH DYNAMIC CHARACT	TERISTICS							
Turn-On Time	T _{ON}	V_{COM} = ±10V, Figure 2, T _A = +25°C			110		ns	
Turn-Off Time	TOFF	$V_{COM} = \pm 10V, F$	igure 2, T _A = +25°C		150		ns	
Charge Injection	Q	$C_L = 1.0$ nF, V_{GEN} T _A = +25°C	I = 0, R _{GEN} = 0, Figure 3,		45		рС	
Off-Isolation (Note 7)	V _{ISO}	$R_L = 50\Omega$, $C_L = 5pF$, f = 1MHz, Figure 4, T _A = +25°C			-60		dB	
Crosstalk (Note 8)	V _{CT}	$\label{eq:RL} \begin{array}{l} R_{L} = 50\Omega, C_{L} = 5pF, f = 1MHz, Figure \; 5, \\ T_{A} = +25^\circC \end{array}$			-66		dB	
NC_ or NO_ Capacitance	COFF	$F = 1MHz$, Figure 6, $T_A = +25^{\circ}C$			65		pF	
COM_ Off-Capacitance	Ссом	$F = 1MHz$, Figure 6, $T_A = +25^{\circ}C$			65		pF	
On-Capacitance	Ссом	$F = 1MHz$, Figure 7, $T_A = +25^{\circ}C$			290		рF	

2.5 Ω , Dual, SPST, CMOS Analog Switches

ELECTRICAL CHARACTERISTICS—Single Supply

 $(V_{+} = +12V, V_{-} = 0V, V_{L} = +5V, V_{IN_{-}H} = +2.4V, V_{IN_{-}L} = +0.8V, T_{A} = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_{A} = +25^{\circ}C$.) (Note 2)

PARAMETER	SYMBOL	CONDIT	MIN	TYP	MAX	UNITS		
ANALOG SWITCH								
Input Voltage Range (Note 3)	V _{COM_} , V _{NO_} , V _{NC_}			VGND		V+	V	
COM_ to NO_, COM_ to NC_	R _{ON}	$I_{COM} = 10mA,$	$T_A = +25^{\circ}C$		3	6	Ω	
On-Resistance		V_{NO} or V_{NC} = 10V	$T_A = T_{MIN}$ to T_{MAX}			7		
COM_ to NO_, COM_ to NC_ On-Resistance Match Between	ΔR _{ON}	$I_{COM} = 10mA$,	$T_A = +25^{\circ}C$		0.05	0.4	Ω	
Channels (Note 4)	2.00	V_{NO} or V_{NC} = 10V	$T_A = T_{MIN}$ to T_{MAX}			0.5		
COM_ to NO_, COM_ to NC_ On-Resistance Flatness	BELATION	I _{COM} _ = 10mA, V _{NO} or V _{NC} = 3V,	$T_A = +25^{\circ}C$		0.05	1.1	Ω	
(Note 5)	R _{FLAT(ON)}	6V, 0V	$T_A = T_{MIN}$ to T_{MAX}			1.2	22	
Off-Leakage Current		$T_A = +25^{\circ}C$	-0.5	+0.01	+0.5	- nA		
(NO_ or NC_) (Notes 6, 9)	I _{NC} _		-2.5		2.5			
COM Off-Leakage Current		V_{COM} = 10V, 1V V_{NO} or V_{NC} = 1V,	$T_A = +25^{\circ}C$	-0.5	+0.01	+0.5	nA	
(Notes 6, 9)	ICOM_(OFF)	10V	$T_A = T_{MIN}$ to T_{MAX}	-2.5		+2.5	ΠA	
COM On-Leakage Current		V_{COM} = 1V, 10V, V _{NO} or V _{NC} = 1V,	$T_A = +25^{\circ}C$	-1	+0.01	+1	n۸	
(Notes 6, 9)	ICOM_(ON)	10V, or unconnected	$T_A = T_{MIN}$ to T_{MAX}	-10		+10	– nA	
LOGIC INPUT								
Input Current with Input Voltage High	IIN_H	V_{IN} = 2.4V, all others = 0.8V		-0.500	+0.001	+0.500	μA	
Input Current with Input Voltage Low	I _{IN_L}	$V_{IN_{}} = 0.8V$, all others = 2.4V		-0.500	+0.001	+0.500	μA	
Logic Input High Voltage	V _{IN_H}			2.4	1.7		V	
Logic Input Low Voltage	V _{IN_L}				1.7	0.8	V	

2.5 Ω , Dual, SPST, CMOS Analog Switches

ELECTRICAL CHARACTERISTICS—Single Supply (continued)

(V+ = +12V, V- = 0V, V_L = +5V, V_{IN_H} = +2.4V, V_{IN_L} = +0.8V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
POWER SUPPLY			- I				I
Power-Supply Range				+4.5		+36.0	V
Positive Supply Current	+	$V_{IN} = 0V \text{ or } 5V$	$T_A = +25^{\circ}C$	-0.5	+0.001	+0.5	
	1+	VIN = 0V 0I 5V	$T_A = T_{MIN}$ to T_{MAX}	-5		+5	μA
Logic Supply Current	li li	$V_{\rm INI} = 0V_{\rm O} cr 5V_{\rm I}$	$T_A = +25^{\circ}C$	-0.5	+0.001	+0.5	
Logic Supply Current	1	$V_{IN} = 0V \text{ or } 5V$	$T_A = T_{MIN}$ to T_{MAX}	-5		+5	- μΑ
Ground Current	laua	I _{GND} V _{IN} = 0V or 5V	$T_A = +25^{\circ}C$	-0.5	+0.001	+0.5	μA
	GND		$T_A = T_{MIN}$ to T_{MAX}	-5		+5	
SWITCH DYNAMIC CHARAC	TERISTICS						
Turn-On Time	t _{ON}	V_{COM} = 10V, Figure 2, T_A = +25°C			110		ns
Turn-Off Time	tOFF	V _{COM} = 10V, Figure	V_{COM} = 10V, Figure 2, T_A = +25°C		130		ns
Charge Injection	Q	$\label{eq:CL} \begin{array}{l} C_L = 1.0nF, V_{GEN} = 0V, R_{GEN} = 0\Omega, \\ \mbox{Figure 3, } T_A = +25^{\circ}C \end{array}$			50		рС
Crosstalk (Note 8)	V _{CT}	$\label{eq:RL} \begin{array}{l} R_L = 50\Omega, C_L = 5pF, f = 1MHz, Figure \; 5, \\ T_A = +25^\circC \end{array}$			66		dB
NC or NO Capacitance	C _(OFF)	$f = 1MHz$, Figure 6, $T_A = +25^{\circ}C$			105		pF
COM Off-Capacitance	C _(COM)	$f = 1MHz$, Figure 6, $T_A = +25^{\circ}C$			105		pF
On-Capacitance	C _(COM)	f = 1MHz, Figure 7,	$T_A = +25^{\circ}C$		185		pF

Note 2: The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet.

Note 3: Guaranteed by design.

Note 4: $\Delta R_{ON} = R_{ON}(MAX) - R_{ON}(MIN)$

Note 5: Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal range.

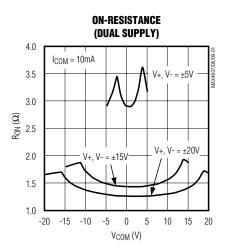
Note 6: Leakage parameters are 100% tested at maximum-rated hot temperature and guaranteed by correlation at +25°C.

Note 7: Off-isolation = 20log10 [VCOM / (VNC or VNO)], VCOM = output, VNC or VNO = input to off switch.

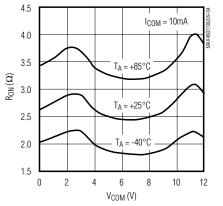
Note 8: Between any two switches Ω .

Note 9: Leakage testing at single supply is guaranteed by testing with dual supplies.

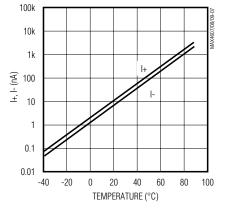
2.5 Ω , Dual, SPST, CMOS Analog Switches



ON-RESISTANCE vs. V_{COM} AND TEMPERATURE (SINGLE SUPPLY)

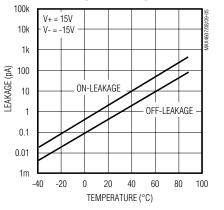


SUPPLY CURRENT vs. TEMPERATURE

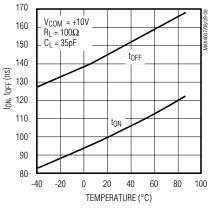


ON-RESISTANCE vs. VCOM AND **TEMPERATURE (DUAL SUPPLY)** 2.6 $V+, V- = \pm 15V$ 2.4 $I_{COM} = 10 mA$ 2.2 -T_A = +85°C 2.0 Ron (Ω) 1.8 1.6 $T_A = +25^{\circ}C$ 1.4 1.2 $T_A = -40^{\circ}C$ 1.0 -15 -10 -5 0 5 10 15 $V_{COM}(V)$

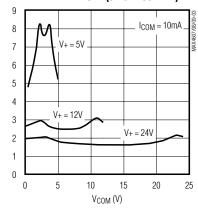
ON/OFF-LEAKAGE CURRENT vs. TEMPERATURE



ON/OFF TIME vs. TEMPERATURE

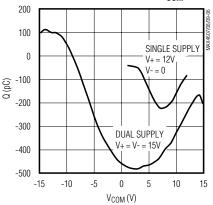


ON-RESISTANCE vs. V_{COM} AND Temperature (Single Supply)

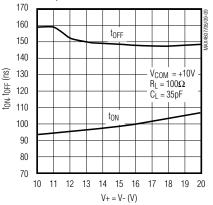


 $R_{ON}(\Omega)$

CHARGE INJECTION vs. V_{COM}



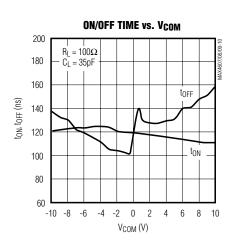
ON/OFF TIME vs. SUPPLY VOLTAGE

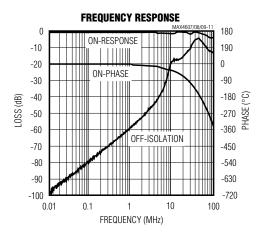


Maxim Integrated

Typical Operating Characteristics (continued)

 $(T_A = +25^{\circ}C, unless otherwise noted.)$





Pin Description

	PIN		NAME	FUNCTION	
MAX4607	MAX4608	MAX4609	NAME	FUNCTION	
2, 7	2, 7	2, 7	IN2, IN2	Logic-Control Digital Inputs	
14, 11	14, 11	14, 11	COM1, COM2	Analog Switch, Common Terminals	
16, 9	_	_	NC1, NC2	Analog Switch, Normally Closed Terminals	
_	16, 9	_	NO1, NO2 Analog Switch, Normally Open Terminals		
_	_	9	NC1	Analog Switch, Normally Closed Terminal	
_		16	NO1 Analog Switch, Normally Open Terminal		
4	4	4	V- Negative Analog Supply-Voltage Input. Connect to DGNI single-supply operation.		
5	5	5	GND	Ground	
1, 3, 6, 8, 10, 15	1, 3, 6, 8, 10, 15	1, 3, 6, 8, 10, 15	N.C. No Connection. Not internally connected. Connect to G low impedance to improve on/off-isolation.		
12	12	12	VL	Logic-Supply Input	
13	13	13	V+	Positive Analog-Supply Input	

Applications Information

Overvoltage Protection

Proper power-supply sequencing is recommended for all CMOS devices. Do not exceed the absolute maximum ratings, because stresses beyond the listed ratings can cause permanent damage to the devices. Always sequence V+ on first, then V-, followed by the logic inputs, NO, or COM. If power-supply sequencing is not possible, add two small signal diodes (D1, D2) in series with supply pins for overvoltage protection (Figure 1). Adding diodes reduces the analog signal range to one diode drop below V+ and one diode drop above V-, but does not affect the devices' low switch resistance and low leakage characteristics. Device operation is unchanged, and the difference between V+ and V- should not exceed 44V. These protection diodes are not recommended when using a single supply.

Off-Isolation at High Frequencies

With the N.C. pins connected to GND, the high-frequency on-response of these parts extends from DC to above 100MHz with a typical loss of -2dB. When the switch is turned off, however, it behaves like a capacitor, and off-isolation decreases with increasing frequency. (Above 300MHz, the switch actually passes more signal turned off than turned on.) This effect is more pronounced with higher source and load impedances. Above 5MHz, circuit-board layout becomes critical, and it becomes difficult to characterize the response of the switch independent of the circuit. The graphs shown in the *Typical Operating Characteristics* were taken using a 50 Ω source and load connected with BNC connectors to a circuit board deemed "average;" that is, designed with isolation in mind, but not using strip-line or other special RF circuit techniques. For critical applications above 5MHz, use the MAX440, MAX441, and MAX442, which are fully characterized up to 160MHz.

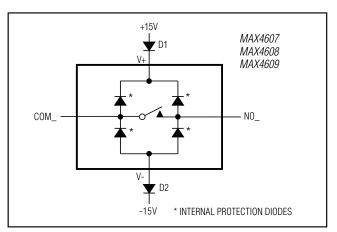
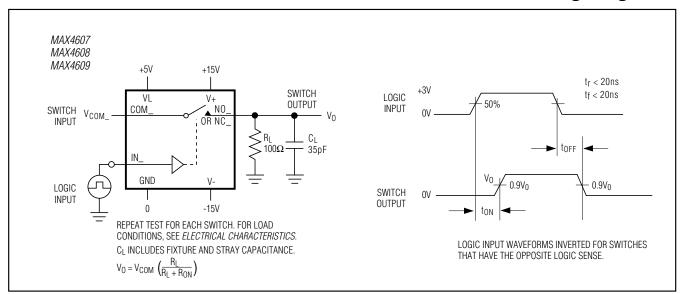


Figure 1. Overvoltage Protection Using External Blocking Diodes



Test Circuits/Timing Diagrams

Figure 2. Switching-Time Test Circuit

2.5 Ω , Dual, SPST, CMOS Analog Switches

Test Circuits/Timing Diagrams (continued)

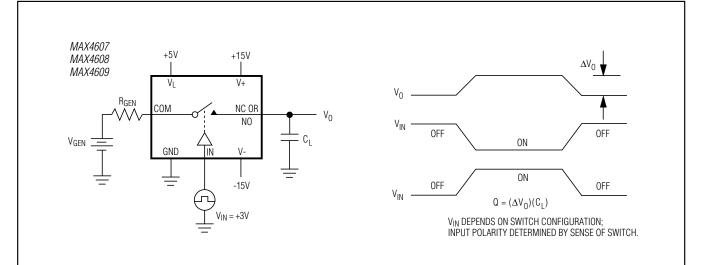
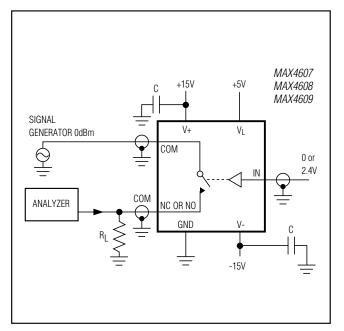


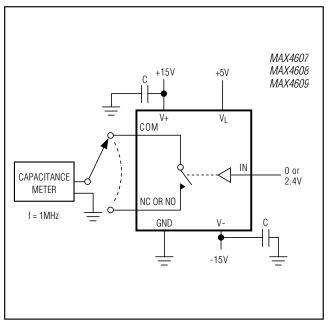
Figure 3. Charge-Injection Test Circuit



MAX4607 С +15V +5V MAX4608 MAX4609 SIGNAL V. V_{L} 50Ω GENERATOR 0dBm COM1 N01 $\overline{\mathbb{Q}}$ ĮN2 IN1 0 or 2.4V 0 or 2.4V -COM2 N02 ANALYZER N.C. GND V-С --15V _

Figure 4. Off-Isolation Test Circuit

Figure 5. Crosstalk Test Circuit



Test Circuits/Timing Diagrams (continued)

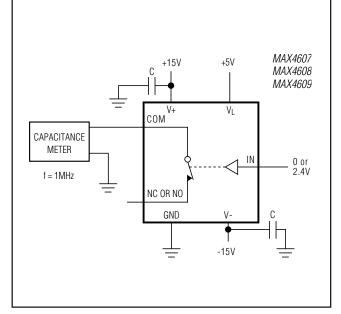


Figure 7. Switch On-Capacitance Test Circuit

PART	TEMP RANGE	PIN-PACKAGE
MAX4608CSE	-0°C to +70°C	16 Narrow SO
MAX4608CPE	0°C to +70°C	16 Plastic DIP
MAX4608ESE	-40°C to +85°C	16 Narrow SO
MAX4608EPE	-40°C to +85°C	16 Plastic DIP
MAX4608MSE/PR3	-55°C to +125°C	16 Narrow SO
MAX4609CSE	-0°C to +70°C	16 Narrow SO
MAX4609CPE	-0°C to +70°C	16 Plastic DIP
MAX4609ESE	-40°C to +85°C	16 Narrow SO
MAX4609EPE	-40°C to +85°C	16 Plastic DIP

Ordering Information (continued)

Figure 6. Switch Off-Capacitance Test Circuit

Devices are also available in a lead(Pb)-free/RoHS-compliant package. Specify lead-free by adding "+" to the part number when ordering.

Chip Information

PROCESS: BICMOS

Package Information

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
16 PDIP	P16-4	<u>21-0043</u>	—
16 SO	S16-8	<u>21-0041</u>	<u>90-0097</u>